ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Composi- © Copyright 2005. IPC, international and Pan-A	Bannockt	burn, Illinois. A	ll rights reserved un tions.	nder both	This docume level parts, t	ent is a decla the declaratio	ration of the s	substances es all lowe	within the mar r level material	ufacturer listed s for which the	l item. N e manufa	Note: if the acturer has	e item is an asso s engineering re	embly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier Information															
Company name*	Company uni	Company unique ID			Unique ID Authority					Response Date*					
onsemi								2024-05-09							
Contact Name Title - Conta			lact !			Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product			Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - I			le - Representative			Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective D	fective Date Version Manufacturing Site		Site	Weigh	nt*	UOM	Unit Type		
	MC74HC4053ADTR2 L G		LOG CMOS MLTIPLXR TRPL		,	2024-05-09		1	PH1		45.4		mg	Each	
Manufacturing Proccess Informatio	n		-			•		·			- -				
Terminal Plating / Grid Array Mater	ial 7	Terminal Base Alloy		-STD-020 MS	L Rating	Peak Pr	Peak Process Body Temperatu		ure Max Time at Peak Temp		perature Number of Reflow Cycles		es		
Precious metal (e.g. Ag,Au, NiPdAu) (no CU Sn)		CU Alloy 1				260		С	C 30		seconds 3				
Comments			· · ·												
evel 1 - maximum time at peak temperature	during so	ldering is 10-3	0 seconds												
or more information regarding material con	nposition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.0	mg	Supplier	Silicon (Si)	7440-21-3		2	mg
Die Attach	1.32	mg	Supplier	Silver (Ag)	7440-22-4		0.99	mg
			Supplier	Epoxy resins	129915-35-1		0.33	mg
Lead Frame	20.76	mg	Supplier	Zinc (Zn)	7440-66-6		0.0249	mg
			Supplier	Iron (Fe)	7439-89-6		0.4879	mg
			Supplier	Copper (Cu)	7440-50-8		20.241	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0062	mg
Mold Compound-Black	19.0	mg		Epoxy resin	proprietary data		0.95	mg
			Supplier	Phenolic Resin	Proprietary Data		0.95	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.38	mg
			Supplier	Carbon Black (C)	1333-86-4		0.095	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		16.625	mg
Plating	2.12	mg	Supplier	Palladium (Pd)	7440-05-3		0.1611	mg
			В	Nickel (Ni)	7440-02-0		1.9292	mg
			Supplier	Gold (Au)	7440-57-5		0.0297	mg
Vire Bond - Cu	0.2	mg	Supplier	Copper (Cu)	7440-50-8		0.2	mg